PSMN038-100K



N-channel TrenchMOS SiliconMAX standard level FET

Rev. 02 — 25 November 2009

Product data sheet

1. Product profile

1.1 General description

SiliconMAX standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in computing, communications, consumer and industrial applications only.

1.2 Features and benefits

- Low conduction losses due to low on-state resistance
- Suitable for high frequency applications due to fast switching characteristics

1.3 Applications

- Computer motherboards
- DC-to-DC convertors

Switched-mode power supplies

1.4 Quick reference data

Table 1. Quick reference

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DS}	drain-source voltage	$T_j \ge 25 \text{ °C}; T_j \le 150 \text{ °C}$	-	-	100	V
I_D	drain current	$T_{sp} = 80 \text{ °C};$ see <u>Figure 1</u> and <u>3</u>	-	-	6.3	Α
P _{tot}	total power dissipation	T _{sp} = 80 °C; see <u>Figure 2</u>	-	-	3.5	W
Dynamic	characteristics					
Q_{GD}	gate-drain charge	$V_{GS} = 10 \text{ V}; I_D = 6.3 \text{ A};$ $V_{DS} = 50 \text{ V}; T_j = 25 \text{ °C};$ see Figure 11	-	16	21.5	nC
Static ch	Static characteristics					
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 5.2 \text{ A};$ $T_j = 25 \text{ °C};$ see Figure 9 and 10	-	33	38	mΩ



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Pinning information

Pinning information Table 2.

Pin	Symbol	Description	Simplified outline	Graphic symbol	
1	S	source			
2	S	source	8 <u> </u>	D	
3	S	source		$G \longrightarrow \overline{A}$	
4	G	gate			
5	D	drain	1	mbb076 S	
6	D	drain	SOT96-1 (SO8)		
7	D	drain			
8	D	drain			

Ordering information 3.

Table 3. **Ordering information**

Type number	Package				
	Name	Description	Version		
PSMN038-100K	SO8	plastic small outline package; 8 leads; body width 3.9 mm	SOT96-1		

Limiting values

Limiting values

Product data sheet

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 150 °C	-	100	V
V_{GS}	gate-source voltage		-20	20	V
I_D	drain current	T_{sp} = 80 °C; see <u>Figure 1</u> and <u>3</u>	-	6.3	Α
I_{DM}	peak drain current	T_{sp} = 25 °C; $t_p \le 10 \mu s$; pulsed; see Figure 3	-	50	Α
P _{tot}	total power dissipation	T _{sp} = 80 °C; see <u>Figure 2</u>	-	3.5	W
T _{stg}	storage temperature		-55	150	°C
Tj	junction temperature		-55	150	°C
Source-dr	ain diode				
Is	source current	$T_{sp} = 80 ^{\circ}C$	-	3.1	Α
I _{SM}	peak source current	T_{sp} = 25 °C; $t_p \le 10 \mu s$; pulsed	-	50	Α

Product data sheet

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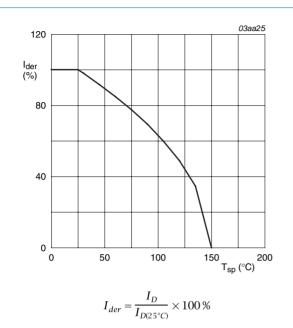
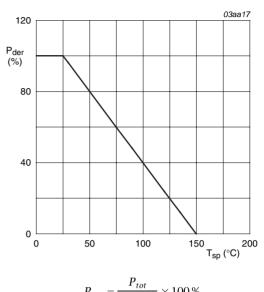


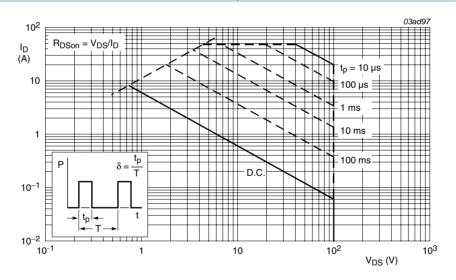
Fig 1. Normalized continuous drain current as a function of solder point temperature



$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$$

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Fig 2. Normalized total power dissipation as a function of solder point temperature



 $T_{sp} = 25$ °C; I_{DM} is single pulse

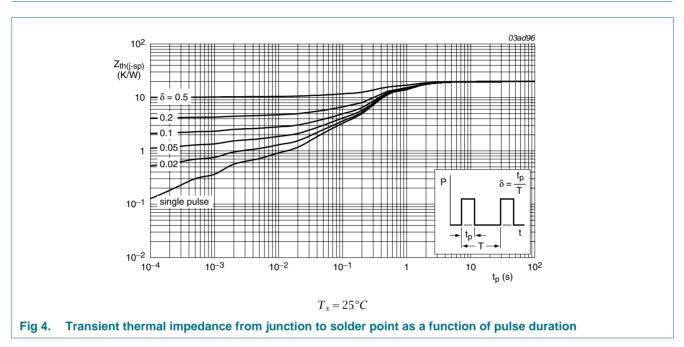
Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

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5. Thermal characteristics

Table 5. Thermal characteristics

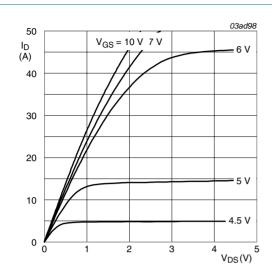
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point	mounted on a metal clad substrate;see Figure 4	-	-	20	K/W



6. Characteristics

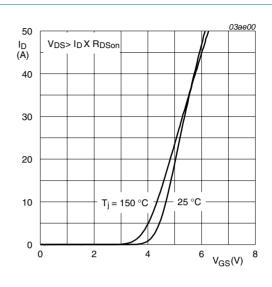
Table 6. Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 250 \mu A; V_{GS} = 0 V; T_j = 25 °C$	100	130	-	V
V _{GS(th)}	gate-source threshold voltage	I_D = 1 mA; V_{DS} = V_{GS} ; T_j = 150 °C; see <u>Figure 8</u>	1.2	-	-	V
		$I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = -55$ °C; see <u>Figure 8</u>	-	-	6	V
		$I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = 25$ °C; see Figure 8	2	-	4	V
I _{DSS} drain leakage current		$V_{DS} = 100 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 150 ^{\circ}\text{C}$	-	-	0.5	mΑ
		$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C}$	-	-	1	μΑ
I _{GSS}	gate leakage current	$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C}$	-	-	100	nA
		$V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	100	nA
R _{DSon} drain-source on-staresistance	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 5.2 \text{ A}; T_j = 150 ^{\circ}\text{C};$ see Figure 9 and 10	-	76	88	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 5.2 \text{ A}; T_j = 25 ^{\circ}\text{C};$ see Figure 9 and 10	-	33	38	mΩ
Dynamic (characteristics					
Q _{G(tot)}	total gate charge	$I_D = 6.3 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$	-	43	-	nC
Q_{GS}	gate-source charge	T _j = 25 °C; see <u>Figure 11</u>	-	6.5	-	nC
Q_{GD}	gate-drain charge		-	16	21.5	nC
C _{iss}	input capacitance	$V_{DS} = 25 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$	-	1740	-	pF
C _{oss}	output capacitance	$T_j = 25 ^{\circ}\text{C}$; see Figure 12	-	220	-	pF
C _{rss}	reverse transfer capacitance		-	135	-	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 50 \text{ V}; R_L = 50 \Omega; V_{GS} = 10 \text{ V};$	-	15	30	ns
t _r	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 \text{ °C}; I_D = 1 \text{ A}$	-	13	25	ns
t _{d(off)}	turn-off delay time		-	50	80	ns
t _f	fall time		-	25	40	ns
9 _{fs}	transfer conductance	$V_{DS} = 15 \text{ V}; I_D = 6.3 \text{ A}; \text{ see } \frac{\text{Figure } 13}{\text{ Figure } 13}$	-	20	-	S
Source-di	rain diode					
V_{SD}	source-drain voltage	$I_S = 2.3 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C};$ see <u>Figure 14</u>	-	0.7	1.1	V
t _{rr}	reverse recovery time	$I_S = 6.3 \text{ A}$; $dI_S/dt = -100 \text{ A/}\mu\text{s}$; $V_{GS} = 0 \text{ V}$;	-	85	-	ns
Qr	recovered charge	$V_{DS} = 25 \text{ V}; T_j = 25 \text{ °C}$	-	0.3	-	μC



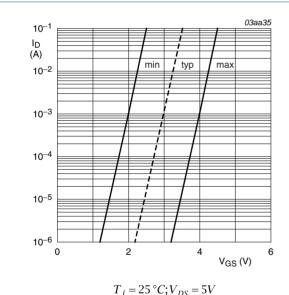
Output characteristics: drain current as a Fig 5. function of drain-source voltage; typical values

 $T_i = 25^{\circ}C$

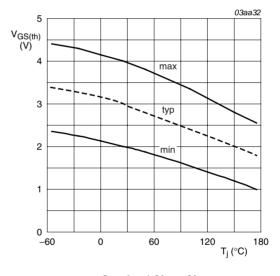


 $T_i = 25$ °C and 150°C; $V_{DS} > I_D \times R_{DSon}$

Fig 6. Transfer characteristics: drain current as a function of gate-source voltage; typical values



Sub-threshold drain current as a function of gate-source voltage



 $I_D = 1 \, mA; V_{DS} = V_{GS}$

Fig 8. Gate-source threshold voltage as a function of junction temperature

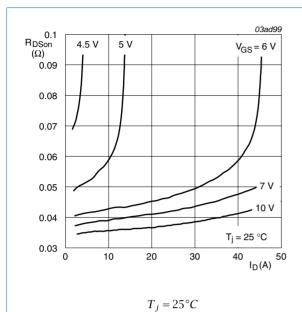


Fig 9. Drain-source on-state resistance as a function of drain current; typical values

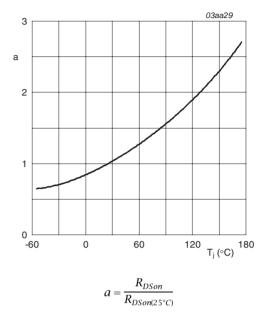
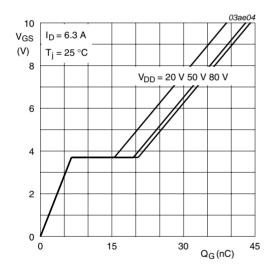
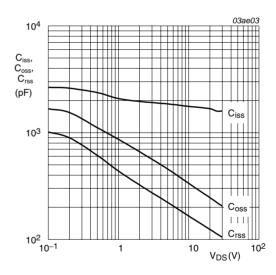


Fig 10. Normalized drain-source on-state resistance factor as a function of junction temperature



 $I_D = 6.3A; V_{DS} = 20V, 50V \text{ and } 80V$

Fig 11. Gate-source voltage as a function of gate charge; typical values



$$V_{GS} = 0V; f = 1MHz$$

Fig 12. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

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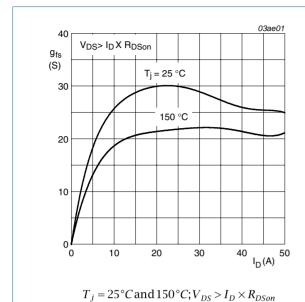


Fig 13. Forward transconductance as a function of drain current; typical values

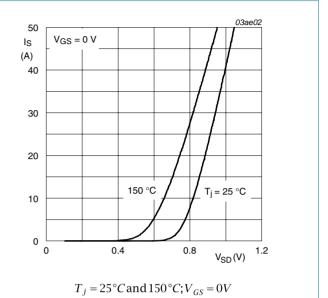
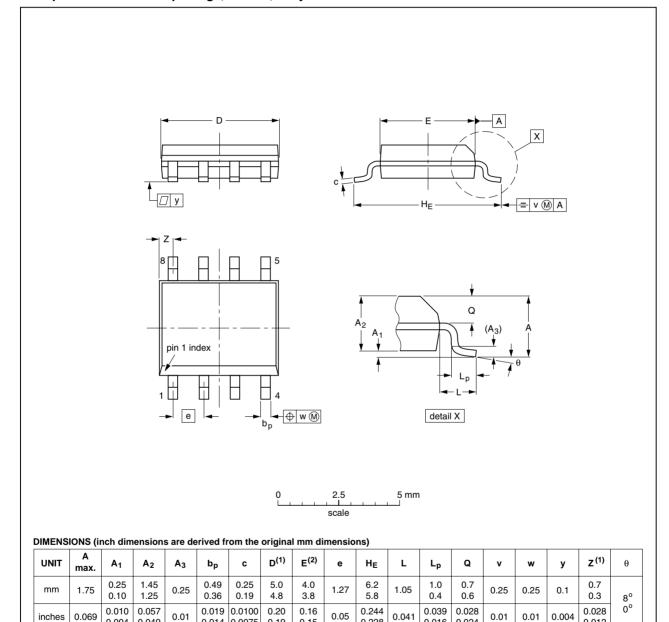


Fig 14. Source current as a function of source-drain voltage; typical values

Package outline

SO8: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1



inches

0.069

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

0.014 0.0075

0.01

2. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

OUTLINE			REFER	ENCES	EUROPEAN	ISSUE DATE
VERS	SION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT	96-1	076E03	MS-012			99-12-27 03-02-18

0.05

0.041

0.016

0.024

0.228

0.01

0.01

Fig 15. Package outline SOT96-1 (SO8)

0.004

0.049

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Revision history

Table 7. **Revision history**

Product data sheet

Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN038-100K_2	20091125	Product data sheet	-	PSMN038-100K-01
Modifications:		t of this data sheet has be of NXP Semiconductors.	•	ly with the new identity
	 Legal texts 	s have been adapted to the	e new company name v	vhere appropriate.
PSMN038-100K-01	20010116	Product specification	-	-

9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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